

MEDIUM VOLTAGE FAST-SWITCHING NPN POWER TRANSISTOR

- SGS-THOMSON PREFERRED SALESTYPE
- MEDIUM VOLTAGE CAPABILITY
- LOW SPREAD OF DYNAMIC PARAMETERS
- MINIMUM LOT-TO-LOT SPREAD FOR RELIABLE OPERATION
- VERY HIGH SWITCHING SPEED
- FULLY CHARACTERISED AT 125°C

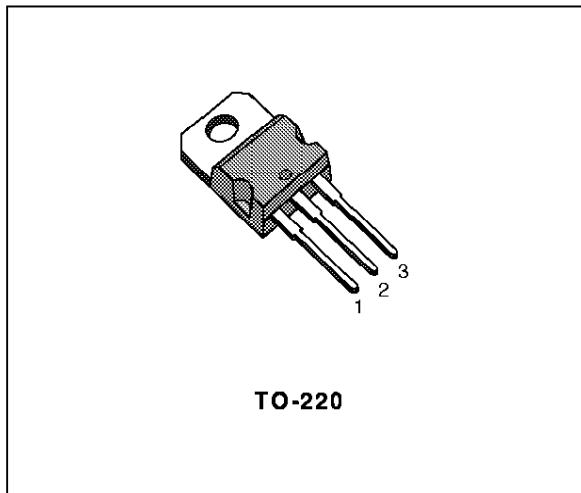
APPLICATIONS

- ELECTRONIC BALLASTS FOR FLUORESCENT LIGHTING
- FLYBACK AND FORWARD SINGLE TRANSISTOR LOW POWER CONVERTERS

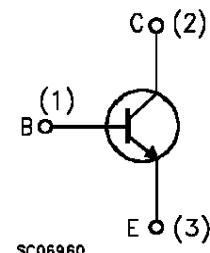
DESCRIPTION

The BUL26 is manufactured using medium voltage Multi Epitaxial Planar technology for high switching speeds and medium voltage capability. It uses a Cellular Emitter structure with planar edge termination to enhance switching speeds while maintaining a wide RBSOA.

The BUL series is designed for use in lighting applications and low cost switch-mode power supplies.



INTERNAL SCHEMATIC DIAGRAM



ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V _{CES}	Collector-Emitter Voltage ($V_{BE} = 0V$)	600	V
V _{CEO}	Collector-Emitter Voltage ($I_B = 0$)	300	V
V _{EBO}	Emitter-Base Voltage ($I_C = 0$)	12	V
I _C	Collector Current	4	A
I _{CM}	Collector Peak Current ($t_p < 5 \text{ ms}$)	8	A
I _B	Base Current	2	A
I _{BM}	Base Peak Current ($t_p < 5 \text{ ms}$)	4	A
P _{tot}	Total Dissipation at $T_c = 25^\circ\text{C}$	60	W
T _{stg}	Storage Temperature	-65 to 150	°C
T _j	Max. Operating Junction Temperature	150	°C

THERMAL DATA

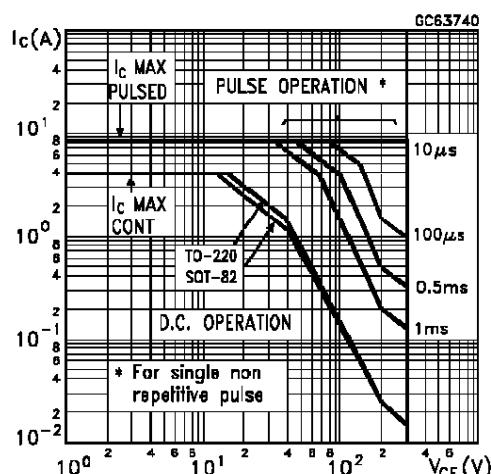
$R_{thj-case}$	Thermal Resistance Junction-case	Max	2.08	$^{\circ}\text{C}/\text{W}$
$R_{thj-amb}$	Thermal Resistance Junction-ambient	Max	100	$^{\circ}\text{C}/\text{W}$

ELECTRICAL CHARACTERISTICS ($T_{case} = 25^{\circ}\text{C}$ unless otherwise specified)

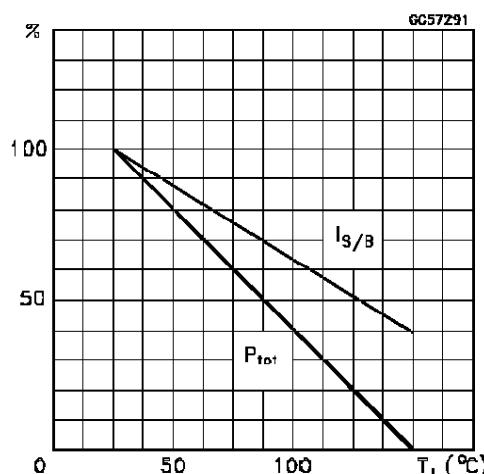
Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
I_{CES}	Collector Cut-off Current ($V_{BE} = 0$)	$V_{CE} = 600 \text{ V}$ $V_{CE} = 600 \text{ V} \quad T_j = 125^{\circ}\text{C}$			100 500	μA μA
I_{CEO}	Collector Cut-off Current ($I_B = 0$)	$V_{CE} = 300 \text{ V}$			250	μA
$V_{CEO(sus)}$	Collector-Emitter Sustaining Voltage	$I_C = 100 \text{ mA} \quad L = 25 \text{ mH}$	300			V
V_{EBO}	Emitter-Base Voltage	$I_E = 10 \text{ mA}$	10			V
$V_{CE(sat)*}$	Collector-Emitter Saturation Voltage	$I_C = 1 \text{ A} \quad I_B = 0.2 \text{ A}$ $I_C = 2 \text{ A} \quad I_B = 0.4 \text{ A}$ $I_C = 3 \text{ A} \quad I_B = 0.6 \text{ A}$			0.5 0.7 1	V V V
$V_{BE(sat)*}$	Base-Emitter Saturation Voltage	$I_C = 1 \text{ A} \quad I_B = 0.2 \text{ A}$ $I_C = 2 \text{ A} \quad I_B = 0.4 \text{ A}$ $I_C = 3 \text{ A} \quad I_B = 0.6 \text{ A}$			1.1 1.2 1.3	V V V
$h_{FE}*$	DC Current Gain	$I_C = 10 \text{ mA} \quad V_{CE} = 5 \text{ V}$ $I_C = 1 \text{ A} \quad V_{CE} = 3 \text{ V}$	10 15		45	
t_s t_f	INDUCTIVE LOAD Storage Time Fall Time	$I_C = 3 \text{ A} \quad I_{B1} = 0.6 \text{ A}$ $V_{BE(off)} = -5 \text{ V} \quad R_{BB} = 0 \Omega$ $V_{CL} = 250 \text{ V} \quad L = 200 \mu\text{H}$		0.8 65	1.5 130	μs ns
t_s t_f	INDUCTIVE LOAD Storage Time Fall Time	$I_C = 3 \text{ A} \quad I_{B1} = 0.6 \text{ A}$ $V_{BE(off)} = -5 \text{ V} \quad R_{BB} = 0 \Omega$ $V_{CL} = 250 \text{ V} \quad L = 200 \mu\text{H}$ $T_j = 125^{\circ}\text{C}$		1.1 120		μs ns

* Pulsed: Pulse duration = 300 μs , duty cycle 1.5 %

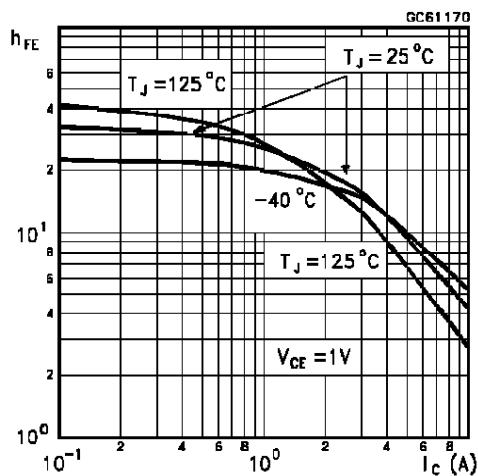
Safe Operating Areas



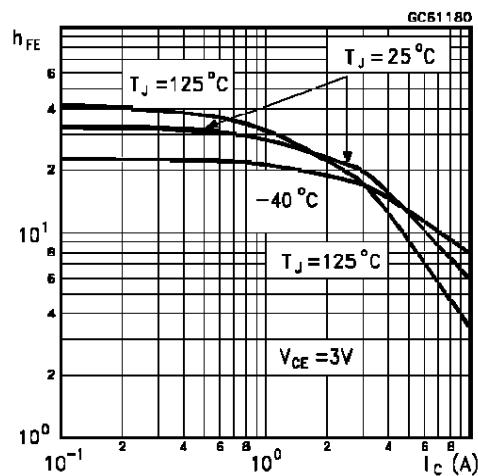
Derating Curves



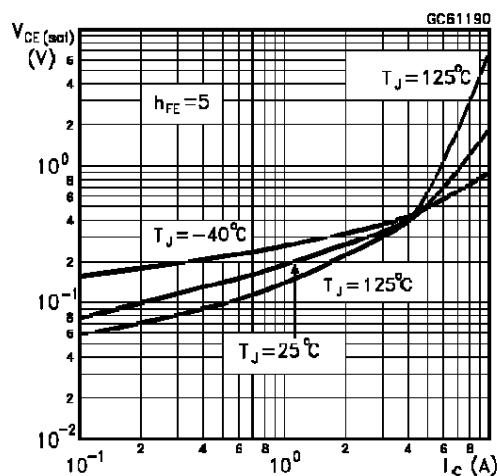
DC Current Gain



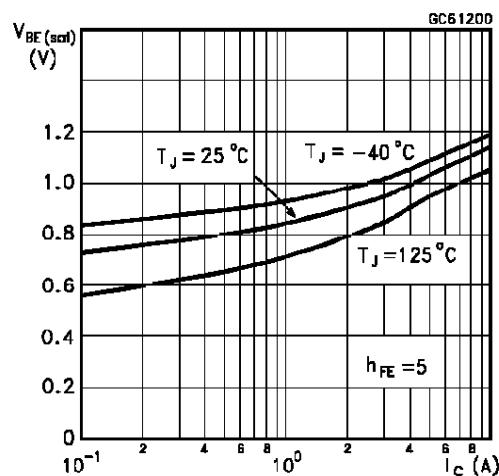
DC Current Gain



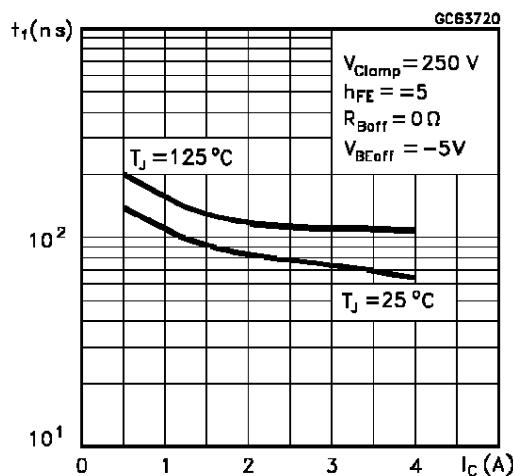
Collector-Emitter Saturation Voltage



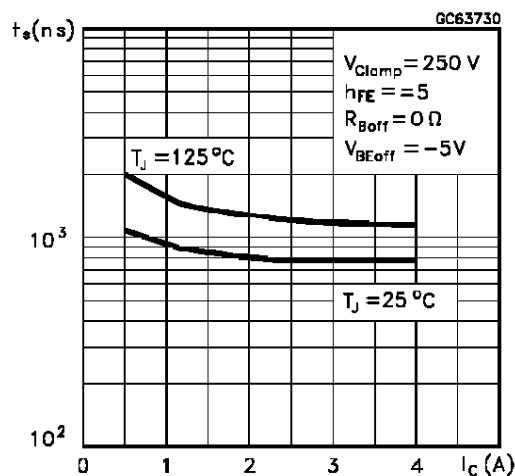
Base-Emitter Saturation Voltage



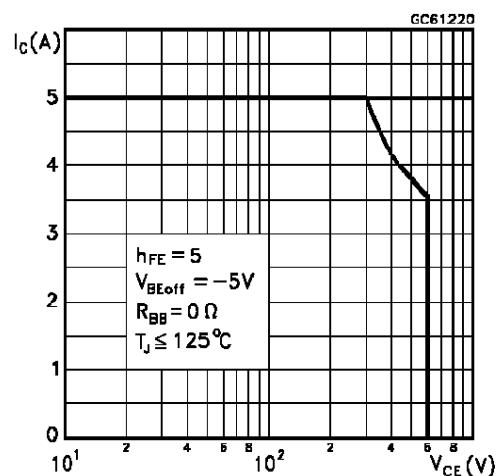
Inductive Fall Time



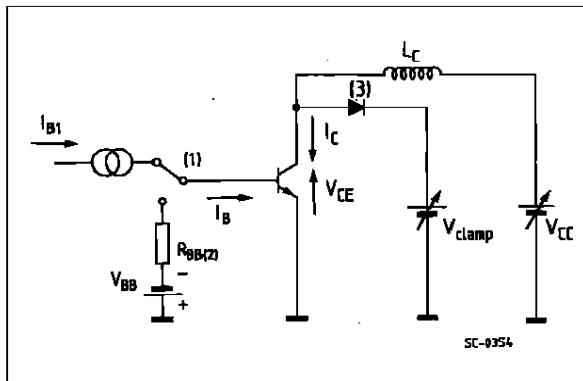
Inductive Storage Time



Reverse Biased SOA

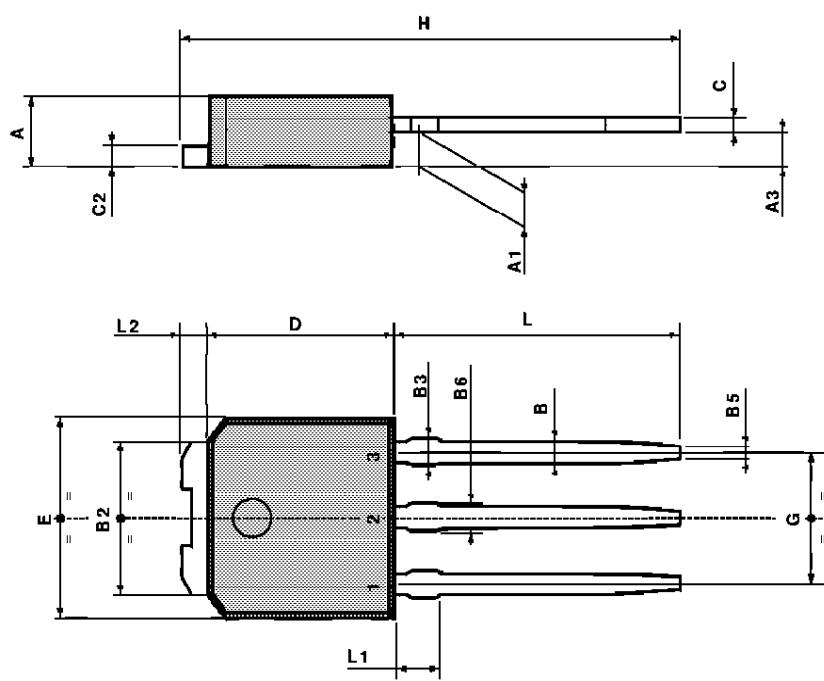


RBSOA and Inductive Load Switching Test Circuit



TO-251 (IPAK) MECHANICAL DATA

DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A	2.2		2.4	0.086		0.094
A1	0.9		1.1	0.035		0.043
A3	0.7		1.3	0.027		0.051
B	0.64		0.9	0.025		0.031
B2	5.2		5.4	0.204		0.212
B3			0.85			0.033
B5		0.3			0.012	
B6			0.95			0.037
C	0.45		0.6	0.017		0.023
C2	0.48		0.6	0.019		0.023
D	6		6.2	0.236		0.244
E	6.4		6.6	0.252		0.260
G	4.4		4.6	0.173		0.181
H	15.9		16.3	0.626		0.641
L	9		9.4	0.354		0.370
L1	0.8		1.2	0.031		0.047
L2		0.8	1		0.031	0.039



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